

# **Dual-Channel Digital Isolators, 5 kV**

## ADuM2200/ADuM2201

#### **FEATURES**

High isolation voltage: 5000 V rms

Low power operation

5 V operation

1.6 mA per channel maximum @ 0 Mbps to 2 Mbps

3.7 mA per channel maximum @ 10 Mbps

3 V operation

1.4 mA per channel maximum @ 0 Mbps to 2 Mbps

2.4 mA per channel maximum @ 10 Mbps

**Bidirectional communication** 

3 V/5 V level translation

High temperature operation: 105°C

High data rate: dc to 10 Mbps (NRZ)

**Precise timing characteristics** 

3 ns maximum pulse width distortion

3 ns maximum channel-to-channel matching

High common-mode transient immunity: >25 kV/ $\mu$ s

16-lead SOIC wide body package (RoHS-compliant models available)

Safety and regulatory approvals

UL recognition: 5000 V rms for 1 minute per UL 1577

(pending)

CSA Component Acceptance Notice #5A (pending)

IEC 60950-1: 600 V rms (reinforced)

IEC 60601-1: 250 V rms (reinforced)

VDE certificate of conformity (pending)

DIN V VDE V 0884-10 (VDE V 0884-10):2006-12

V<sub>IORM</sub> = 846 V peak

#### **APPLICATIONS**

General-purpose, high voltage, multichannel isolation Medical equipment

**Power supplies** 

RS-232/RS-422/RS-485 transceiver isolation

#### **GENERAL DESCRIPTION**

The ADuM220x¹ are 2-channel digital isolators based on Analog Devices, Inc., *i*Coupler® technology. Combining high speed CMOS and monolithic air core transformer technology, these isolation components provide outstanding performance characteristics that are superior to alternatives such as optocoupler devices.

By avoiding the use of LEDs and photodiodes, *i*Coupler devices remove the design difficulties commonly associated with optocouplers. Typical optocoupler concerns regarding uncertain current transfer ratios, nonlinear transfer functions, and temperature and lifetime effects are eliminated with the simple *i*Coupler digital interfaces and stable performance characteristics. The need for external drivers and other discrete components is eliminated with these *i*Coupler products. Furthermore, *i*Coupler devices run at one-tenth to one-sixth the power of optocouplers at comparable signal data rates.

The ADuM220x isolators provide two independent isolation channels in a variety of channel configurations and data rates (see the Ordering Guide). The ADuM220x models operate with the supply voltage of either side ranging from 3.0 V to 5.5 V, providing compatibility with lower voltage systems as well as enabling voltage translation functionality across the isolation barrier. In addition, the ADuM220x provide low pulse width distortion (<3 ns for BRWZ grade) and tight channel-to-channel matching (<3 ns for BRWZ grade). Unlike other optocoupler alternatives, the ADuM220x isolators have a patented refresh feature that ensures dc correctness in the absence of input logic transitions and during power-up/power-down conditions.

#### **FUNCTIONAL BLOCK DIAGRAMS**

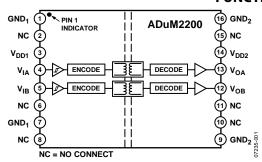


Figure 1. ADuM2200

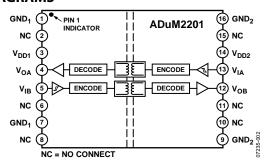


Figure 2. ADuM2201

<sup>&</sup>lt;sup>1</sup> Protected by U.S. Patents 5,952,849, 6,873,065, 6,903,578, and 7,075,329; other patents pending.

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### **REVISION HISTORY**

1/08—Revision 0: Initial Version

### **SPECIFICATIONS**

### **ELECTRICAL CHARACTERISTICS—5 V OPERATION**<sup>1</sup>

 $4.5~V \le V_{DD1} \le 5.5~V$ ,  $4.5~V \le V_{DD2} \le 5.5~V$ . All minimum/maximum specifications apply over the entire recommended operation range, unless otherwise noted. All typical specifications are at  $T_A = 25$ °C,  $V_{DD1} = V_{DD2} = 5~V$ .

Table 1.

| Parameter   | Symbol                              | Min  | Тур   | Max           | Unit  | Test Conditions  |
|---|-------------------------------------|--|-------|---------------|-------|--|
| DC SPECIFICATIONS   |                                     |  |       |               |       |  |
| Input Supply Current, per Channel, Quiescent                                | I <sub>DDI (Q)</sub>                |  | 0.4   | 0.8           | mA    |  |
| Output Supply Current, per Channel, Quiescent                               | I <sub>DDO (Q)</sub>                |  | 0.5   | 0.6           | mA    |  |
| ADuM2200, Total Supply Current, Two Channels <sup>2</sup>                   |                                     |  |       |               |       |  |
| DC to 2 Mbps  |                                     |  |       |               |       |  |
| V <sub>DD1</sub> Supply Current   | I <sub>DD1 (Q)</sub>                |  | 1.3   | 1.7           | mA    | DC to 1 MHz logic signal frequency                                 |
| V <sub>DD2</sub> Supply Current   | I <sub>DD2 (Q)</sub>                |  | 1.0   | 1.6           | mA    | DC to 1 MHz logic signal frequency                                 |
| 10 Mbps (BR Grade Only)   |                                     |  |       |               |       |  |
| V <sub>DD1</sub> Supply Current   | I <sub>DD1 (10)</sub>               |  | 3.5   | 4.6           | mA    | 5 MHz logic signal frequency                                       |
| V <sub>DD2</sub> Supply Current   | I <sub>DD2 (10)</sub>               |  | 1.7   | 2.8           | mA    | 5 MHz logic signal frequency                                       |
| ADuM2201, Total Supply Current, Two Channels <sup>2</sup>                   |                                     |  |       |               |       |  |
| DC to 2 Mbps  |                                     |  |       |               |       |  |
| V <sub>DD1</sub> Supply Current   | I <sub>DD1 (Q)</sub>                |  | 1.1   | 1.5           | mA    | DC to 1 MHz logic signal frequency                                 |
| V <sub>DD2</sub> Supply Current   | I <sub>DD2 (Q)</sub>                |  | 1.3   | 1.8           | mA    | DC to 1 MHz logic signal frequency                                 |
| 10 Mbps (BR Grade Only)   |                                     |  |       |               |       |  |
| V <sub>DD1</sub> Supply Current   | I <sub>DD1</sub> (10)               |  | 2.6   | 3.4           | mA    | 5 MHz logic signal frequency                                       |
| V <sub>DD2</sub> Supply Current   | I <sub>DD2 (10)</sub>               |  | 3.1   | 4.0           | mA    | 5 MHz logic signal frequency                                       |
| For All Models  |                                     |  |       |               | _     |  |
| Input Currents  | I <sub>IA</sub> , I <sub>IB</sub>   | -10  | +0.01 | +10           | μΑ    | $0 \text{ V} \leq V_{IA}, V_{IB} \leq V_{DD1} \text{ or } V_{DD2}$ |
| Logic High Input Threshold  | V <sub>IH</sub>                     | 0.7 (V <sub>DD1</sub><br>or V <sub>DD2</sub> ) |       |               | V     |  |
| Logic Low Input Threshold   | V <sub>IL</sub>                     |  |       | 0.3           | V     |  |
|   |                                     |  |       | $(V_{DD1} or$ |       |  |
|   |                                     |  |       | $V_{DD2}$ )   | .,    |  |
| Logic High Output Voltages  | Voah                                | $(V_{DD1} \text{ or } V_{DD2}) - 0.1$          | 5.0   |               | V     | $I_{Ox} = -20 \mu A, V_{Ix} = V_{IxH}$                             |
|   | V <sub>ОВН</sub>                    | (V <sub>DD1</sub> or V <sub>DD2</sub> ) – 0.5  | 4.8   |               | V     | $I_{Ox} = -4 \text{ mA}, V_{Ix} = V_{IxH}$                         |
| Logic Low Output Voltages   | $V_{OAL}$                           |  | 0.0   | 0.1           | V     | $I_{Ox} = 20 \mu A, V_{Ix} = V_{IxL}$                              |
|   | V <sub>OBL</sub>                    |  | 0.04  | 0.1           | V     | $I_{Ox} = 400 \ \mu A, V_{Ix} = V_{IxL}$                           |
|   |                                     |  | 0.2   | 0.4           | V     | $I_{Ox} = 4 \text{ mA}, V_{Ix} = V_{IxL}$                          |
| SWITCHING SPECIFICATIONS  |                                     |  |       |               |       |  |
| ADuM220xAR  |                                     |  |       |               |       |  |
| Minimum Pulse Width <sup>3</sup>  | PW                                  |  |       | 1000          | ns    | C <sub>L</sub> = 15 pF, CMOS signal levels                         |
| Maximum Data Rate <sup>4</sup>  |                                     | 1  |       |               | Mbps  | C <sub>L</sub> = 15 pF, CMOS signal levels                         |
| Propagation Delay⁵  | t <sub>PHL</sub> , t <sub>PLH</sub> | 20   |       | 150           | ns    | C <sub>L</sub> = 15 pF, CMOS signal levels                         |
| Pulse Width Distortion,  tplh - tphl 5                                      | PWD                                 |  |       | 40            | ns    | C <sub>L</sub> = 15 pF, CMOS signal levels                         |
| Propagation Delay Skew <sup>6</sup>   | t <sub>PSK</sub>                    |  |       | 100           | ns    | C <sub>L</sub> = 15 pF, CMOS signal levels                         |
| Channel-to-Channel Matching <sup>7</sup>                                    | t <sub>PSKCD/OD</sub>               |  |       | 50            | ns    | $C_L = 15 \text{ pF, CMOS signal levels}$                          |
| Output Rise/Fall Time (10% to 90%)  | t <sub>R</sub> /t <sub>F</sub>      |  | 10    |               | ns    | $C_L = 15 \text{ pF, CMOS signal levels}$                          |
| ADuM220xBR  |                                     |  |       |               |       |  |
| Minimum Pulse Width <sup>3</sup>  | PW                                  |  |       | 100           | ns    | $C_L = 15 \text{ pF, CMOS signal levels}$                          |
| Maximum Data Rate <sup>4</sup>  |                                     | 10   |       |               | Mbps  | $C_L = 15 \text{ pF, CMOS signal levels}$                          |
| Propagation Delay⁵  | t <sub>PHL</sub> , t <sub>PLH</sub> | 20   |       | 50            | ns    | $C_L = 15 \text{ pF, CMOS signal levels}$                          |
| Pulse Width Distortion,  t <sub>PLH</sub> - t <sub>PHL</sub>   <sup>5</sup> | PWD                                 |  |       | 3             | ns    | $C_L = 15 \text{ pF, CMOS signal levels}$                          |
| Change vs. Temperature  |                                     |  | 5     |               | ps/°C | C <sub>L</sub> = 15 pF, CMOS signal levels                         |

| Parameter  | Symbol                         | Min | Тур  | Max | Unit    | Test Conditions  |
|--|--------------------------------|-----|------|-----|---------|--|
| Propagation Delay Skew <sup>6</sup>  | t <sub>PSK</sub>               |     |      | 15  | ns      | C <sub>L</sub> = 15 pF, CMOS signal levels   |
| Channel-to-Channel Matching,<br>Codirectional Channels <sup>7</sup>        | <b>t</b> PSKCD                 |     |      | 3   | ns      | C <sub>L</sub> = 15 pF, CMOS signal levels   |
| Channel-to-Channel Matching,<br>Opposing Directional Channels <sup>7</sup> | <b>t</b> PSKOD                 |     |      | 15  | ns      | C <sub>L</sub> = 15 pF, CMOS signal levels   |
| Output Rise/Fall Time (10% to 90%)   | t <sub>R</sub> /t <sub>F</sub> |     | 2.5  |     | ns      | $C_L = 15$ pF, CMOS signal levels  |
| For All Models   |                                |     |      |     |         |  |
| Common-Mode Transient Immunity at Logic High Output <sup>8</sup>           | CM <sub>H</sub>                | 25  | 35   |     | kV/μs   | $V_{lx} = V_{DD1}$ or $V_{DD2}$ , $V_{CM} = 1000$ V, transient magnitude = $800$ V |
| Common-Mode Transient Immunity<br>at Logic Low Output <sup>8</sup>         | CM <sub>L</sub>                | 25  | 35   |     | kV/μs   | VIx = 0 V, VCM = 1000 V,<br>transient magnitude = 800 V                            |
| Refresh Rate   | f <sub>r</sub>                 |     | 1.2  |     | Mbps    |  |
| Input Dynamic Supply Current, per Channel <sup>9</sup>                     | I <sub>DDI (D)</sub>           |     | 0.19 |     | mA/Mbps |  |
| Output Dynamic Supply Current, per Channel <sup>9</sup>                    | I <sub>DDO (D)</sub>           |     | 0.05 |     | mA/Mbps |  |

<sup>&</sup>lt;sup>1</sup> All voltages are relative to their respective ground.

<sup>&</sup>lt;sup>2</sup> The supply current values for both channels are combined when running at identical data rates. Output supply current values are specified with no output load present. The supply current associated with an individual channel operating at a given data rate can be calculated as described in the Power Consumption section. See Figure 6 through Figure 8 for information on per-channel supply current as a function of data rate for unloaded and loaded conditions. See Figure 9 through Figure 11 for total I<sub>DD1</sub> and I<sub>DD2</sub> supply currents as a function of data rate for ADuM2200 and ADuM2201 channel configurations.

<sup>&</sup>lt;sup>3</sup> The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is quaranteed.

<sup>&</sup>lt;sup>4</sup> The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.

<sup>&</sup>lt;sup>5</sup> t<sub>PHL</sub> propagation delay is measured from the 50% level of the falling edge of the V<sub>Ix</sub> signal to the 50% level of the falling edge of the V<sub>Ox</sub> signal. t<sub>PLH</sub> propagation delay is measured from the 50% level of the rising edge of the V<sub>Ix</sub> signal to the 50% level of the v<sub>Ox</sub> signal.

<sup>6</sup> t<sub>PSK</sub> is the magnitude of the worst-case difference in t<sub>PHL</sub> and/or t<sub>PLH</sub> that is measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.

<sup>&</sup>lt;sup>7</sup> Codirectional channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels with inputs on the same side of the isolation barrier. Opposing directional channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels with inputs on opposing sides of the isolation barrier.

 $<sup>^8</sup>$  CM<sub>H</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \, V_{DD2}$ . CM<sub>L</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 < 0.8 \, V$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges. The transient magnitude is the range over which the common mode is slewed.

<sup>&</sup>lt;sup>9</sup> Dynamic supply current is the incremental amount of supply current required for a 1 Mbps increase in the signal data rate. See Figure 6 through Figure 8 for information on per-channel supply current for unloaded and loaded conditions. See the Power Consumption section for guidance on calculating per-channel supply current for a given data rate.

### **ELECTRICAL CHARACTERISTICS—3 V OPERATION<sup>1</sup>**

 $3.0~V \le V_{DD1} \le 3.6~V$ ,  $3.0~V \le V_{DD2} \le 3.6~V$ . All minimum/maximum specifications apply over the entire recommended operation range, unless otherwise noted. All typical specifications are at  $T_A = 25$ °C,  $V_{DD1} = V_{DD2} = 3.0~V$ .

Table 2.

| Parameter   | Symbol                              | Min  | Тур   | Max  | Unit | Test Conditions   |
|---|-------------------------------------|--|-------|--|------|---|
| DC SPECIFICATIONS   |                                     |  |       |  |      |   |
| Input Supply Current, per Channel, Quiescent              | I <sub>DDI (Q)</sub>                |  | 0.3   | 0.5  | mA   |   |
| Output Supply Current, per Channel, Quiescent             | I <sub>DDO (Q)</sub>                |  | 0.3   | 0.5  | mA   |   |
| ADuM2200, Total Supply Current, Two Channels <sup>2</sup> |                                     |  |       |  |      |   |
| DC to 2 Mbps  |                                     |  |       |  |      |   |
| V <sub>DD1</sub> Supply Current                           | I <sub>DD1 (Q)</sub>                |  | 8.0   | 1.3  | mA   | DC to 1 MHz logic signal frequency                                    |
| V <sub>DD2</sub> Supply Current                           | I <sub>DD2 (Q)</sub>                |  | 0.7   | 1.0  | mA   | DC to 1 MHz logic signal frequency                                    |
| 10 Mbps (BR Grade Only)                                   |                                     |  |       |  |      |   |
| V <sub>DD1</sub> Supply Current                           | I <sub>DD1 (10)</sub>               |  | 2.0   | 3.2  | mA   | 5 MHz logic signal frequency  |
| V <sub>DD2</sub> Supply Current                           | I <sub>DD2 (10)</sub>               |  | 1.1   | 1.7  | mA   | 5 MHz logic signal frequency  |
| ADuM2201, Total Supply Current, Two Channels <sup>2</sup> |                                     |  |       |  |      |   |
| DC to 2 Mbps  |                                     |  |       |  |      |   |
| V <sub>DD1</sub> Supply Current                           | I <sub>DD1 (Q)</sub>                |  | 0.7   | 1.3  | mA   | DC to 1 MHz logic signal frequency                                    |
| V <sub>DD2</sub> Supply Current                           | I <sub>DD2 (Q)</sub>                |  | 0.8   | 1.6  | mA   | DC to 1 MHz logic signal frequency                                    |
| 10 Mbps (BR Grade Only)                                   |                                     |  |       |  |      |   |
| V <sub>DD1</sub> Supply Current                           | I <sub>DD1 (10)</sub>               |  | 1.5   | 2.1  | mA   | 5 MHz logic signal frequency  |
| V <sub>DD2</sub> Supply Current                           | I <sub>DD2 (10)</sub>               |  | 1.9   | 2.4  | mA   | 5 MHz logic signal frequency  |
| For All Models  |                                     |  |       |  |      |   |
| Input Currents  | I <sub>IA</sub> , I <sub>IB</sub>   | -10  | +0.01 | +10  | μΑ   | $0 \text{ V} \leq V_{IA}$ , $V_{IB} \leq V_{DD1} \text{ or } V_{DD2}$ |
| Logic High Input Threshold                                | V <sub>IH</sub>                     | $\begin{array}{c} 0.7  (V_{DD1} \\ or  V_{DD2}) \end{array}$ |       |  | V    |   |
| Logic Low Input Threshold                                 | VIL                                 |  |       | $\begin{array}{c} 0.3 \ (V_{DD1} \\ or \ V_{DD2}) \end{array}$ | V    |   |
| Logic High Output Voltages                                | Voah                                | $(V_{DD1} \text{ or } V_{DD2}) - 0.1$                        | 3.0   |  | V    | $I_{Ox} = -20 \mu A, V_{Ix} = V_{IxH}$                                |
|   | V <sub>ОВН</sub>                    | $(V_{DD1} \text{ or } V_{DD2}) - 0.5$                        | 2.8   |  | V    | $I_{Ox} = -4 \text{ mA, } V_{Ix} = V_{IxH}$                           |
| Logic Low Output Voltages                                 | $V_{OAL}$                           |  | 0.0   | 0.1  | ٧    | $I_{Ox} = 20 \mu A, V_{Ix} = V_{IxL}$                                 |
|   | V <sub>OBL</sub>                    |  | 0.04  | 0.1  | ٧    | $I_{Ox} = 400 \mu A, V_{lx} = V_{lxL}$                                |
|   |                                     |  | 0.2   | 0.4  | ٧    | $I_{Ox} = 4 \text{ mA}, V_{lx} = V_{lxL}$                             |
| SWITCHING SPECIFICATIONS                                  |                                     |  |       |  |      |   |
| ADuM220xAR  |                                     |  |       |  |      |   |
| Minimum Pulse Width <sup>3</sup>                          | PW                                  |  |       | 1000   | ns   | $C_L = 15 \text{ pF, CMOS signal levels}$                             |
| Maximum Data Rate⁴  |                                     | 1  |       |  | Mbps | C <sub>L</sub> = 15 pF, CMOS signal levels                            |
| Propagation Delay⁵  | t <sub>PHL</sub> , t <sub>PLH</sub> | 20   |       | 150  | ns   | $C_L = 15$ pF, CMOS signal levels                                     |
| Pulse Width Distortion,  tplh - tphl 5                    | PWD                                 |  |       | 40   | ns   | C <sub>L</sub> = 15 pF, CMOS signal levels                            |
| Propagation Delay Skew <sup>6</sup>                       | t <sub>PSK</sub>                    |  |       | 100  | ns   | $C_L = 15$ pF, CMOS signal levels                                     |
| Channel-to-Channel Matching <sup>7</sup>                  | t <sub>PSKCD/OD</sub>               |  |       | 50   | ns   | C <sub>L</sub> = 15 pF, CMOS signal levels                            |
| Output Rise/Fall Time (10% to 90%)                        | t <sub>R</sub> /t <sub>F</sub>      |  | 10    |  | ns   | C <sub>L</sub> = 15 pF, CMOS signal levels                            |
| ADuM220xBR  |                                     |  |       |  |      |   |
| Minimum Pulse Width <sup>3</sup>                          | PW                                  |  |       | 100  | ns   | $C_L = 15$ pF, CMOS signal levels                                     |
| Maximum Data Rate <sup>4</sup>                            |                                     | 10   |       |  | Mbps | $C_L = 15$ pF, CMOS signal levels                                     |
| Propagation Delay⁵  | t <sub>PHL</sub> , t <sub>PLH</sub> | 20   |       | 60   | ns   | $C_L = 15$ pF, CMOS signal levels                                     |
| Pulse Width Distortion,  tplh -tphl 5                     | PWD                                 |  |       | 3  | ns   | C <sub>L</sub> = 15 pF, CMOS signal levels                            |

| Parameter  | Symbol                         | Min | Тур  | Max | Unit    | Test Conditions   |
|--|--------------------------------|-----|------|-----|---------|---|
| Change vs. Temperature   |                                |     | 5    |     | ps/°C   | $C_L = 15$ pF, CMOS signal levels   |
| Propagation Delay Skew <sup>6</sup>  | t <sub>PSK</sub>               |     |      | 22  | ns      | $C_L = 15$ pF, CMOS signal levels   |
| Channel-to-Channel Matching,<br>Codirectional Channels <sup>7</sup>        | <b>t</b> PSKCD                 |     |      | 3   | ns      | C <sub>L</sub> = 15 pF, CMOS signal levels  |
| Channel-to-Channel Matching,<br>Opposing Directional Channels <sup>7</sup> | <b>t</b> <sub>PSKOD</sub>      |     |      | 22  | ns      | C <sub>L</sub> = 15 pF, CMOS signal levels  |
| Output Rise/Fall Time (10% to 90%)   | t <sub>R</sub> /t <sub>F</sub> |     | 3.0  |     | ns      | $C_L = 15 \text{ pF, CMOS signal levels}$   |
| For All Models   |                                |     |      |     |         |   |
| Common-Mode Transient Immunity<br>at Logic High Output <sup>8</sup>        | CM <sub>H</sub>                | 25  | 35   |     | kV/μs   | $V_{lx} = V_{DD1}$ or $V_{DD2}$ , $V_{CM} = 1000$ V, transient magnitude = $800$ V        |
| Common-Mode Transient Immunity<br>at Logic Low Output <sup>8</sup>         | CM <sub>L</sub>                | 25  | 35   |     | kV/μs   | $V_{lx} = 0 \text{ V}, V_{CM} = 1000 \text{ V},$<br>transient magnitude = $800 \text{ V}$ |
| Refresh Rate   | fr                             |     | 1.1  |     | Mbps    |   |
| Input Dynamic Supply Current, per Channel <sup>9</sup>                     | I <sub>DDI (D)</sub>           |     | 0.10 |     | mA/Mbps |   |
| Output Dynamic Supply Current, per Channel <sup>9</sup>                    | I <sub>DDO (D)</sub>           |     | 0.03 |     | mA/Mbps |   |

<sup>&</sup>lt;sup>1</sup> All voltages are relative to their respective ground.

<sup>&</sup>lt;sup>2</sup> The supply current values for both channels are combined when running at identical data rates. Output supply current values are specified with no output load present. The supply current associated with an individual channel operating at a given data rate can be calculated as described in the Power Consumption section. See Figure 6 through Figure 8 for information on per-channel supply current as a function of data rate for unloaded and loaded conditions. See Figure 9 through Figure 11 for total I<sub>DD1</sub> and I<sub>DD2</sub> supply currents as a function of data rate for ADuM2200 and ADuM2201 channel configurations.

<sup>&</sup>lt;sup>3</sup> The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is quaranteed.

<sup>&</sup>lt;sup>4</sup> The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.

<sup>5</sup> t<sub>PHL</sub> propagation delay is measured from the 50% level of the falling edge of the V<sub>Ix</sub> signal to the 50% level of the falling edge of the V<sub>Ox</sub> signal. t<sub>PLH</sub> propagation delay is measured from the 50% level of the rising edge of the V<sub>Ix</sub> signal to the 50% level of the V<sub>Ox</sub> signal.

<sup>6</sup> t<sub>PSK</sub> is the magnitude of the worst-case difference in t<sub>PHL</sub> and/or t<sub>PLH</sub> that is measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.

<sup>&</sup>lt;sup>7</sup> Codirectional channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels with inputs on the same side of the isolation barrier. Opposing directional channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels with inputs on opposing sides of the isolation barrier.

 $<sup>^8</sup>$  CM<sub>H</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 \, V_{DD2}$ . CM<sub>L</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 < 0.8 \, V$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges. The transient magnitude is the range over which the common mode is slewed.

<sup>&</sup>lt;sup>9</sup> Dynamic supply current is the incremental amount of supply current required for a 1 Mbps increase in the signal data rate. See Figure 6 through Figure 8 for information on per-channel supply current for unloaded and loaded conditions. See the Power Consumption section for guidance on calculating per-channel supply current for a given data rate.

### ELECTRICAL CHARACTERISTICS—MIXED 5 V/3 V OR 3 V/5 V OPERATION<sup>1</sup>

5 V/3 V operation:  $4.5 \text{ V} \le V_{DD1} \le 5.5 \text{ V}$ ,  $3.0 \text{ V} \le V_{DD2} \le 3.6 \text{ V}$ . 3 V/5 V operation:  $3.0 \text{ V} \le V_{DD1} \le 3.6 \text{ V}$ ,  $4.5 \text{ V} \le V_{DD2} \le 5.5 \text{ V}$ . All minimum/maximum specifications apply over the entire recommended operation range, unless otherwise noted. All typical specifications are at  $T_A = 25^{\circ}\text{C}$ ;  $V_{DD1} = 3.0 \text{ V}$ ,  $V_{DD2} = 5 \text{ V}$ ; or  $V_{DD1} = 5 \text{ V}$ ,  $V_{DD2} = 3.0 \text{ V}$ .

Table 3.

| Parameter  | Symbol                | Min | Тур | Max | Unit | Test Conditions                    |
|--|-----------------------|-----|-----|-----|------|------------------------------------|
| DC SPECIFICATIONS  |                       |     |     |     |      |                                    |
| Input Supply Current, per Channel, Quiescent                 | I <sub>DDI (Q)</sub>  |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 0.4 | 0.8 | mA   |                                    |
| 3 V/5 V Operation  |                       |     | 0.3 | 0.5 | mA   |                                    |
| Output Supply Current, per Channel, Quiescent                | I <sub>DDO (Q)</sub>  |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 0.3 | 0.5 | mA   |                                    |
| 3 V/5 V Operation  |                       |     | 0.5 | 0.6 | mA   |                                    |
| ADuM2200, Total Supply Current, Two<br>Channels <sup>2</sup> |                       |     |     |     |      |                                    |
| DC to 2 Mbps   |                       |     |     |     |      |                                    |
| V <sub>DD1</sub> Supply Current                              | I <sub>DD1 (Q)</sub>  |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 1.3 | 1.7 | mA   | DC to 1 MHz logic signal frequency |
| 3 V/5 V Operation  |                       |     | 0.8 | 1.3 | mA   | DC to 1 MHz logic signal frequency |
| V <sub>DD2</sub> Supply Current                              | I <sub>DD2 (Q)</sub>  |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 0.7 | 1.0 | mA   | DC to 1 MHz logic signal frequency |
| 3 V/5 V Operation  |                       |     | 1.0 | 1.6 | mA   | DC to 1 MHz logic signal frequency |
| 10 Mbps (BR Grade Only)                                      |                       |     |     |     |      |                                    |
| V <sub>DD1</sub> Supply Current                              | I <sub>DD1 (10)</sub> |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 3.5 | 4.6 | mA   | 5 MHz logic signal frequency       |
| 3 V/5 V Operation  |                       |     | 2.0 | 3.2 | mA   | 5 MHz logic signal frequency       |
| V <sub>DD2</sub> Supply Current                              | I <sub>DD2 (10)</sub> |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 1.1 | 1.7 | mA   | 5 MHz logic signal frequency       |
| 3 V/5 V Operation  |                       |     | 1.7 | 2.8 | mA   | 5 MHz logic signal frequency       |
| ADuM2201, Total Supply Current, Two Channels <sup>2</sup>    |                       |     |     |     |      |                                    |
| DC to 2 Mbps   |                       |     |     |     |      |                                    |
| V <sub>DD1</sub> Supply Current                              | I <sub>DD1 (Q)</sub>  |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 1.1 | 1.5 | mA   | DC to 1 MHz logic signal frequency |
| 3 V/5 V Operation  |                       |     | 0.7 | 1.3 | mA   | DC to 1 MHz logic signal frequency |
| V <sub>DD2</sub> Supply Current                              | I <sub>DD2 (Q)</sub>  |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 0.8 | 1.6 | mA   | DC to 1 MHz logic signal frequency |
| 3 V/5 V Operation  |                       |     | 1.3 | 1.8 | mA   | DC to 1 MHz logic signal frequency |
| 10 Mbps (BR Grade Only)                                      |                       |     |     |     |      |                                    |
| V <sub>DD1</sub> Supply Current                              | I <sub>DD1 (10)</sub> |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 2.6 | 3.4 | mA   | 5 MHz logic signal frequency       |
| 3 V/5 V Operation  |                       |     | 1.5 | 2.1 | mA   | 5 MHz logic signal frequency       |
| V <sub>DD2</sub> Supply Current                              | I <sub>DD2 (10)</sub> |     |     |     |      |                                    |
| 5 V/3 V Operation  |                       |     | 1.9 | 2.4 | mA   | 5 MHz logic signal frequency       |
| 3 V/5 V Operation  |                       |     | 3.1 | 4.0 | mA   | 5 MHz logic signal frequency       |

| Parameter  | Symbol                                 | Min   | Тур                                   | Max                            | Unit    | Test Conditions   |
|--|--|---|---------------------------------------|--------------------------------|---------|---|
| For All Models   |  |   |                                       |                                |         |   |
| Input Currents   | I <sub>IA</sub> , I <sub>IB</sub>      | -10   | +0.01                                 | +10                            | μΑ      | $0 \text{ V} \leq V_{IA}, V_{IB} \leq V_{DD1} \text{ or } V_{DD2}$                                |
| Logic High Input Threshold   | V <sub>IH</sub>                        | 0.7 (V <sub>DD1</sub> or V <sub>DD2</sub> )   |                                       |                                | V       |   |
| Logic Low Input Threshold  | V <sub>IL</sub>                        | 31.1502,                                      |                                       | 0.3<br>(V <sub>DD1</sub><br>or | V       |   |
| Logic High Output Voltages   | V <sub>OAH</sub> ,<br>V <sub>OBH</sub> | (V <sub>DD1</sub> or V <sub>DD2</sub> ) – 0.1 | $(V_{DD1} \text{ or } V_{DD2})$       | V <sub>DD2</sub> )             | V       | $I_{Ox} = -20  \mu A$ , $V_{Ix} = V_{IxH}$  |
|  | V OBH                                  | $(V_{DD1} \text{ or } V_{DD2}) = 0.1$         | $(V_{DD1} \text{ or } V_{DD2}) - 0.2$ |                                | V       | $I_{0x} = -4 \text{ mA, } V_{1x} = V_{1xH}$   |
| Logic Low Output Voltages  | V <sub>OAL</sub> , V <sub>OBL</sub>    | 1002)   | 0.0                                   | 0.1                            | V       | $I_{Ox} = 20 \mu A, V_{Ix} = V_{IxL}$   |
| Logic Low Output Voltages  | VOAL/ VOBL                             |   | 0.04                                  | 0.1                            | V       | $I_{Ox} = 400 \mu\text{A}, V_{Ix} = V_{IxL}$  |
|  |  |   | 0.2                                   | 0.4                            | V       | $I_{Ox} = 4 \text{ mA}, V_{Ix} = V_{IxL}$   |
| SWITCHING SPECIFICATIONS   |  |   |                                       |                                | •       | TOX TITLE TIME  |
| ADuM220xAR   |  |   |                                       |                                |         |   |
| Minimum Pulse Width <sup>3</sup>   | PW                                     |   |                                       | 1000                           | ns      | $C_L = 15 \text{ pF, CMOS signal levels}$   |
| Maximum Data Rate <sup>4</sup>   | 1                                      | 1   |                                       |                                | Mbps    | $C_L = 15 \text{ pF, CMOS signal levels}$   |
| Propagation Delay <sup>5</sup>   | t <sub>PHL</sub> , t <sub>PLH</sub>    | 15  |                                       | 150                            | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Pulse Width Distortion,  t <sub>PLH</sub> - t <sub>PHL</sub>  5            | PWD                                    |   |                                       | 40                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Propagation Delay Skew <sup>6</sup>  | t <sub>PSK</sub>                       |   |                                       | 50                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Channel-to-Channel Matching <sup>7</sup>                                   | t <sub>PSKCD/OD</sub>                  |   |                                       | 50                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Output Rise/Fall Time (10% to 90%)   | t <sub>R</sub> /t <sub>F</sub>         |   | 10                                    | 30                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| ADuM220xBR   |  |   | 10                                    |                                |         |   |
| Minimum Pulse Width <sup>3</sup>   | PW                                     |   |                                       | 100                            | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Maximum Data Rate <sup>4</sup>   |  | 10  |                                       |                                | Mbps    | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Propagation Delay⁵   | t <sub>PHL</sub> , t <sub>PLH</sub>    | 15  |                                       | 55                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Pulse Width Distortion, $ t_{PLH} - t_{PHL} ^5$                            | PWD                                    |   |                                       | 3                              | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Change vs. Temperature   |  |   | 5                                     |                                | ps/°C   | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Propagation Delay Skew <sup>6</sup>  | t <sub>PSK</sub>                       |   |                                       | 22                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Channel-to-Channel Matching,<br>Codirectional Channels <sup>7</sup>        | <b>t</b> <sub>PSKCD</sub>              |   |                                       | 3                              | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Channel-to-Channel Matching,<br>Opposing Directional Channels <sup>7</sup> | t <sub>PSKOD</sub>                     |   |                                       | 22                             | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| Output Rise/Fall Time (10% to 90%)   | t <sub>R</sub> /t <sub>F</sub>         |   |                                       |                                |         |   |
| 5 V/3 V Operation  |  |   | 3.0                                   |                                | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| 3 V/5 V Operation  |  |   | 2.5                                   |                                | ns      | C <sub>L</sub> = 15 pF, CMOS signal level   |
| 5 V/3 V Operation  |  |   | 3.0                                   |                                | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| 3 V/5 V Operation  |  |   | 2.5                                   |                                | ns      | $C_L = 15 \text{ pF, CMOS signal level}$  |
| For All Models   |  |   |                                       |                                |         |   |
| Common-Mode Transient Immunity<br>at Logic High Output <sup>8</sup>        | CM <sub>H</sub>                        | 25  | 35                                    |                                | kV/μs   | $V_{lx} = V_{DD1}$ or $V_{DD2}$ , $V_{CM} = 1000 \text{ V}$ transient magnitude = $800 \text{ V}$ |
| Common-Mode Transient Immunity<br>at Logic Low Output <sup>8</sup>         | CM <sub>L</sub>                        | 25  | 35                                    |                                | kV/μs   | $V_{lx} = 0 \text{ V}, V_{CM} = 1000 \text{ V},$<br>transient magnitude = 800 V                   |
| Refresh Rate   | fr                                     |   |                                       |                                |         |   |
| 5 V/3 V Operation  |  |   | 1.2                                   |                                | Mbps    |   |
| 3 V/5 V Operation  |  |   | 1.1                                   |                                | Mbps    |   |
| Input Dynamic Supply Current, per Channel <sup>9</sup>                     | I <sub>DDI (D)</sub>                   |   |                                       |                                |         |   |
| 5 V/3 V Operation  |  |   | 0.19                                  |                                | mA/Mbps |   |
| 3 V/5 V Operation  |  |   | 0.10                                  |                                | mA/Mbps |   |

| Parameter  | Symbol               | Min | Тур  | Max | Unit    | Test Conditions |
|--|----------------------|-----|------|-----|---------|-----------------|
| Output Dynamic Supply Current,<br>per Channel <sup>9</sup> | I <sub>DDO (D)</sub> |     |      |     |         |                 |
| 5 V/3 V Operation  |                      |     | 0.03 |     | mA/Mbps |                 |
| 3 V/5 V Operation  |                      |     | 0.05 |     | mA/Mbps |                 |

<sup>&</sup>lt;sup>1</sup> All voltages are relative to their respective ground.

<sup>&</sup>lt;sup>2</sup> The supply current values for both channels are combined when running at identical data rates. Output supply current values are specified with no output load present. The supply current associated with an individual channel operating at a given data rate can be calculated as described in the Power Consumption section. See Figure 6 through Figure 8 for information on per-channel supply current as a function of data rate for unloaded and loaded conditions. See Figure 9 through Figure 11 for total l<sub>DD1</sub> and l<sub>DD2</sub> supply currents as a function of data rate for ADuM2200 and ADuM2201 channel configurations.

<sup>&</sup>lt;sup>3</sup> The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is guaranteed.

<sup>&</sup>lt;sup>4</sup> The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.

 $<sup>^5</sup>$  t<sub>PHL</sub> propagation delay is measured from the 50% level of the falling edge of the V<sub>Ix</sub> signal to the 50% level of the falling edge of the V<sub>Ox</sub> signal. t<sub>PLH</sub> propagation delay is measured from the 50% level of the rising edge of the V<sub>Ix</sub> signal to the 50% level of the V<sub>Ox</sub> signal.

<sup>&</sup>lt;sup>6</sup> t<sub>PSK</sub> is the magnitude of the worst-case difference in t<sub>PHL</sub> and/or t<sub>PLH</sub> that is measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.

<sup>&</sup>lt;sup>7</sup> Codirectional channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels with inputs on the same side of the isolation barrier. Opposing directional channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels with inputs on opposing sides of the isolation barrier.

 $<sup>^8</sup>$  CM<sub>H</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 > 0.8 V_{DD2}$ . CM<sub>L</sub> is the maximum common-mode voltage slew rate that can be sustained while maintaining  $V_0 < 0.8 V$ . The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges. The transient magnitude is the range over which the common mode is slewed.

<sup>&</sup>lt;sup>9</sup> Dynamic supply current is the incremental amount of supply current required for a 1 Mbps increase in the signal data rate. See Figure 6 through Figure 8 for information on per-channel supply current for unloaded and loaded conditions. See the Power Consumption section for guidance on calculating per-channel supply current for a given data rate.

#### **PACKAGE CHARACTERISTICS**

Table 4.

| Parameter                                      | Symbol                | Min Typ | Max | Unit | Test Conditions             |
|--|-----------------------|---------|-----|------|-----------------------------|
| Resistance (Input-to-Output) <sup>1</sup>      | R <sub>I-O</sub>      | 1013    | 2   | Ω    |                             |
| Capacitance (Input-to-Output) <sup>1</sup>     | C <sub>I-O</sub>      | 2.2     |     | pF   | f = 1 MHz                   |
| Input Capacitance <sup>2</sup>                 | Cı                    | 4.0     |     | pF   |                             |
| IC Junction-to-Case Thermal Resistance, Side 1 | $\theta_{\text{JCI}}$ | 33      |     | °C/W | Thermocouple located at     |
| IC Junction-to-Case Thermal Resistance, Side 2 | θιсο                  | 28      |     | °C/W | center of package underside |

Device considered a 2-terminal device: Pin 1 through Pin 8 are shorted together and Pin 9 through Pin 16 are shorted together.

#### **REGULATORY INFORMATION**

The ADuM220x are approved by the organizations listed in Table 5. Refer to Table 10 and the Insulation Lifetime section for details regarding recommended maximum working voltages for specific cross-isolation waveforms and insulation levels.

Table 5.

| UL (Pending)  | CSA (Pending)  | VDE (Pending)   |
|---|--|---|
| Recognized under the UL 1577 component recognition program <sup>1</sup> | Approved under CSA Component<br>Acceptance Notice #5A  | Certified according to DIN V VDE V 0884-10 (VDE V 0884-10):2006-12 <sup>2</sup> |
| Double/reinforced insulation,<br>5000 V rms isolation voltage           | Reinforced insulation per CSA 60950-1-03<br>and IEC 60950-1, 600 V rms (848 V peak)<br>maximum working voltage | Reinforced insulation, 846 V peak   |
|   | Reinforced insulation per IEC 60601-1<br>250 V rms (353 V peak) maximum working<br>voltage                     |   |
| File E214100  | File 205078  | File 2471900-4880-0001  |

#### INSULATION AND SAFETY-RELATED SPECIFICATIONS

Table 6.

| Parameter  | Symbol | Value     | Unit  | Conditions   |
|--|--------|-----------|-------|--|
| Rated Dielectric Insulation Voltage              |        | 5000      | V rms | 1-minute duration  |
| Minimum External Air Gap (Clearance)             | L(I01) | 7.46 min  | mm    | Measured from input terminals to output terminals, shortest distance through air     |
| Minimum External Tracking (Creepage)             | L(102) | 8.10 min  | mm    | Measured from input terminals to output terminals, shortest distance path along body |
| Minimum Internal Gap (Internal Clearance)        |        | 0.017 min | mm    | Insulation distance through insulation   |
| Tracking Resistance (Comparative Tracking Index) | CTI    | >175      | V     | DIN IEC 112/VDE 0303 Part 1  |
| Isolation Group                                  |        | Illa      |       | Material Group (DIN VDE 0110, 1/89, Table 1)   |

<sup>&</sup>lt;sup>2</sup> Input capacitance is from any input data pin to ground.

 $<sup>^{1}</sup>$  In accordance with UL 1577, each ADuM220x is proof-tested by applying an insulation test voltage ≥ 6000 V rms for 1 second (current leakage detection limit = 10 μA).  $^{2}$  In accordance with DIN V VDE V 0884-10, each ADuM220x is proof-tested by applying an insulation test voltage ≥1590 V peak for 1 second (partial discharge detection limit = 5 pC). The asterisk (\*) branded on the component designates DIN V VDE V 0884-10 approval.

### DIN V VDE V 0884-10 (VDE V 0884-10) INSULATION CHARACTERISTICS

These isolators are suitable for reinforced electrical isolation only within the safety limit data. Maintenance of the safety data is ensured by means of protective circuits. Note that the asterisk (\*) branded on packages denotes DIN V VDE V 0884-10 approval for 846 V peak working voltage.

Table 7.

| Description  | Conditions   | Symbol            | Characteristic | Unit   |
|--|--|-------------------|----------------|--------|
| Installation Classification per DIN VDE 0110             |  |                   |                |        |
| For Rated Mains Voltage ≤ 300 V rms                      |  |                   | I to IV        |        |
| For Rated Mains Voltage ≤ 450 V rms                      |  |                   | l to II        |        |
| For Rated Mains Voltage ≤ 600 V rms                      |  |                   | l to II        |        |
| Climatic Classification                                  |  |                   | 40/105/21      |        |
| Pollution Degree (DIN VDE 0110, Table 1)                 |  |                   | 2              |        |
| Maximum Working Insulation Voltage                       |  | V <sub>IORM</sub> | 846            | V peak |
| Input-to-Output Test Voltage, Method B1                  | $V_{IORM} \times 1.875 = V_{PR}$ , 100% production test, $t_m = 1$ sec, partial discharge < 5 pC | $V_{PR}$          | 1590           | V peak |
| Input-to-Output Test Voltage, Method A                   |  | $V_{PR}$          |                |        |
| After Environmental Tests Subgroup 1                     | $V_{IORM} \times 1.6 = V_{PR}$ , $t_m = 60$ sec, partial discharge $< 5$ pC                      |                   | 1375           | V peak |
| After Input and/or Safety Test Subgroup 2 and Subgroup 3 | $V_{IORM} \times 1.2 = V_{PR}$ , $t_m = 60$ sec, partial discharge $< 5$ pC                      |                   | 1018           | V peak |
| Highest Allowable Overvoltage                            | Transient overvoltage, $t_{TR} = 10$ seconds   | $V_{TR}$          | 6000           | V peak |
| Safety-Limiting Values                                   | Maximum value allowed in the event of a failure; see Figure 3                                    |                   |                |        |
| Case Temperature   |  | Ts                | 150            | °C     |
| Side 1 Current   |  | I <sub>S1</sub>   | 265            | mA     |
| Side 2 Current   |  | I <sub>S2</sub>   | 335            | mA     |
| Insulation Resistance at T <sub>S</sub>                  | $V_{10} = 500 \text{ V}$   | Rs                | >109           | Ω      |

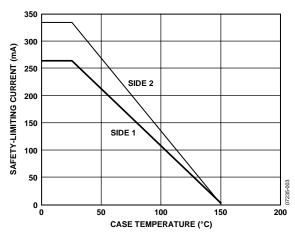


Figure 3. Thermal Derating Curve, Dependence of Safety Limiting Values with Case Temperature per DIN V VDE V 0884-10

#### RECOMMENDED OPERATING CONDITIONS

Table 8.

| Parameter                        | Symbol             | Min | Max  | Unit |
|----------------------------------|--------------------|-----|------|------|
| Operating Temperature            | TA                 | -40 | +105 | °C   |
| Supply Voltages <sup>1</sup>     | $V_{DD1}, V_{DD2}$ | 3.0 | 5.5  | V    |
| Input Signal Rise and Fall Times |                    |     | 1.0  | ms   |

<sup>&</sup>lt;sup>1</sup> All voltages are relative to their respective ground. See the DC Correctness and Magnetic Field Immunity section for information on immunity to external magnetic fields.

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 9.

| Parameter   | Rating                        |
|---|-------------------------------|
| Storage Temperature (T <sub>ST</sub> )                                  | −65°C to +150°C               |
| Ambient Operating Temperature (T <sub>A</sub> )                         | -40°C to +105°C               |
| Supply Voltages (V <sub>DD1</sub> , V <sub>DD2</sub> ) <sup>1</sup>     | -0.5 V to +7.0 V              |
| Input Voltage $(V_{IA}, V_{IB}, V_{IC}, V_{ID}, V_{E1}, V_{E2})^{1, 2}$ | $-0.5$ V to $V_{DDI} + 0.5$ V |
| Output Voltage (VoA, VoB, Voc, VoD) <sup>1, 2</sup>                     | $-0.5V$ to $V_{DDO}+0.5V$     |
| Average Output Current per Pin <sup>3</sup>                             |                               |
| Side 1 (I <sub>01</sub> )   | -18 mA to $+18$ mA            |
| Side 2 (I <sub>O2</sub> )   | -22 mA to +22 mA              |
| Common-Mode Transients <sup>4</sup>                                     | –100 kV/μs to +100 kV/μs      |

<sup>&</sup>lt;sup>1</sup> All voltages are relative to their respective ground.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

Table 10. Maximum Continuous Working Voltage<sup>1</sup>

| Parameter                     | Max | Unit   | Constraint   |
|-------------------------------|-----|--------|--|
| AC Voltage, Bipolar Waveform  | 565 | V peak | 50 year minimum lifetime   |
| AC Voltage, Unipolar Waveform |     |        |  |
| Reinforced Insulation         | 846 | V peak | Maximum approved working voltage per IEC 60950-1 and VDE V 0884-10 |
| DC Voltage                    |     |        |  |
| Reinforced Insulation         | 846 | V peak | Maximum approved working voltage per IEC 60950-1 and VDE V 0884-10 |

<sup>&</sup>lt;sup>1</sup> Refers to continuous voltage magnitude imposed across the isolation barrier. See the Insulation Lifetime section for more details.

Table 11. ADuM2200 Truth Table (Positive Logic)

| V <sub>IA</sub> Input | V <sub>IB</sub> Input | V <sub>DD1</sub> State | V <sub>DD2</sub> State | V <sub>OA</sub> Output | V <sub>OB</sub> Output | Notes  |
|-----------------------|-----------------------|------------------------|------------------------|------------------------|------------------------|--|
| Н                     | Н                     | Powered                | Powered                | Н                      | Н                      |  |
| L                     | L                     | Powered                | Powered                | L                      | L                      |  |
| Н                     | L                     | Powered                | Powered                | Н                      | L                      |  |
| L                     | Н                     | Powered                | Powered                | L                      | Н                      |  |
| X                     | X                     | Unpowered              | Powered                | Н                      | Н                      | Outputs return to the input state within 1 $\mu$ s of $V_{DDI}$ power restoration. |
| X                     | X                     | Powered                | Unpowered              | Indeterminate          | Indeterminate          | Outputs return to the input state within 1 $\mu$ s of $V_{DDO}$ power restoration. |

Table 12. ADuM2201 Truth Table (Positive Logic)

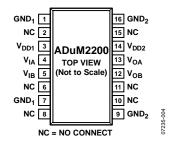
| V <sub>IA</sub> Input | V <sub>IB</sub> Input | V <sub>DD1</sub> State | V <sub>DD2</sub> State | Voa Output    | V <sub>OB</sub> Output | Notes  |
|-----------------------|-----------------------|------------------------|------------------------|---------------|------------------------|--|
| Н                     | Н                     | Powered                | Powered                | Н             | Н                      |  |
| L                     | L                     | Powered                | Powered                | L             | L                      |  |
| Н                     | L                     | Powered                | Powered                | Н             | L                      |  |
| L                     | Н                     | Powered                | Powered                | L             | Н                      |  |
| X                     | X                     | Unpowered              | Powered                | Indeterminate | Н                      | Outputs return to the input state within 1 $\mu$ s of $V_{DDI}$ power restoration. |
| X                     | X                     | Powered                | Unpowered              | Н             | Indeterminate          | Outputs return to the input state within 1 $\mu$ s of $V_{DDO}$ power restoration. |

 $<sup>^2</sup>$   $V_{\text{DDI}}$  and  $V_{\text{DDO}}$  refer to the supply voltages on the input and output sides of a given channel, respectively. See the PC Board Layout section.

<sup>&</sup>lt;sup>3</sup> See Figure 3 for maximum rated current values for various temperatures.

<sup>&</sup>lt;sup>4</sup> Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the Absolute Maximum Rating can cause latch-up or permanent damage.

### PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

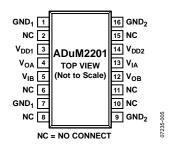


- 1. PIN 1 AND PIN 7 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>1</sub> IS RECOMMENDED.
  2. PIN 9 AND PIN 16 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

Figure 4. ADuM2200 Pin Configuration

Table 13. ADuM2200 Pin Function Descriptions

| Pin No. | Mnemonic         | Description   |
|---------|------------------|---|
| 1       | GND <sub>1</sub> | Ground 1. Ground reference for isolator Side 1.     |
| 2       | NC               | No internal connection.                             |
| 3       | $V_{\text{DD1}}$ | Supply Voltage for Isolator Side 1, 3.0 V to 5.5 V. |
| 4       | VIA              | Logic Input A.                                      |
| 5       | $V_{IB}$         | Logic Input B.                                      |
| 6       | NC               | No internal connection.                             |
| 7       | GND <sub>1</sub> | Ground 1. Ground reference for isolator Side 1.     |
| 8       | NC               | No internal connection.                             |
| 9       | GND <sub>2</sub> | Ground 2. Ground reference for isolator Side 2.     |
| 10      | NC               | No internal connection.                             |
| 11      | NC               | No internal connection.                             |
| 12      | $V_{OB}$         | Logic Output B.                                     |
| 13      | $V_{OA}$         | Logic Output A.                                     |
| 14      | $V_{\text{DD2}}$ | Supply Voltage for Isolator Side 2, 3.0 V to 5.5 V. |
| 15      | NC               | No internal connection.                             |
| 16      | GND <sub>2</sub> | Ground 2. Ground reference for isolator Side 2.     |



- NOTES:

  1. PIN 1 AND PIN 7 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>1</sub> IS RECOMMENDED.

  2. PIN 9 AND PIN 16 ARE INTERNALLY CONNECTED, AND CONNECTING BOTH TO GND<sub>2</sub> IS RECOMMENDED.

Figure 5. ADuM2201 Pin Configuration

Table 14. ADuM2201 Pin Function Descriptions

| Pin No. | Mnemonic         | Description   |
|---------|------------------|---|
| 1       | GND <sub>1</sub> | Ground 1. Ground reference for isolator Side 1.     |
| 2       | NC               | No internal connection.                             |
| 3       | $V_{DD1}$        | Supply Voltage for Isolator Side 1, 3.0 V to 5.5 V. |
| 4       | $V_{OA}$         | Logic Output A.                                     |
| 5       | $V_{IB}$         | Logic Input B.                                      |
| 6       | NC               | No internal connection.                             |
| 7       | $GND_1$          | Ground 1. Ground reference for isolator Side 1.     |
| 8       | NC               | No internal connection.                             |
| 9       | $GND_2$          | Ground 2. Ground reference for isolator Side 2.     |
| 10      | NC               | No internal connection.                             |
| 11      | NC               | No internal connection.                             |
| 12      | $V_{\text{OB}}$  | Logic Output B.                                     |
| 13      | $V_{IA}$         | Logic Input A.                                      |
| 14      | $V_{\text{DD2}}$ | Supply Voltage for Isolator Side 2, 3.0 V to 5.5 V. |
| 15      | NC               | No internal connection.                             |
| 16      | GND <sub>2</sub> | Ground 2. Ground reference for isolator Side 2.     |

### TYPICAL PERFORMANCE CHARACTERISTICS

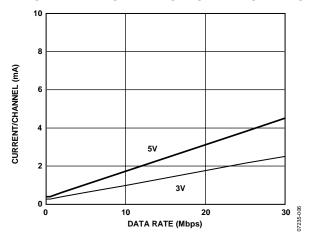


Figure 6. Typical Input Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (No Output Load)

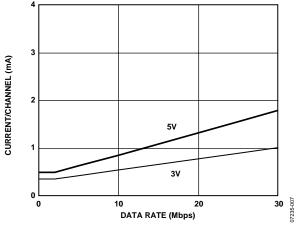


Figure 7. Typical Output Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (No Output Load)

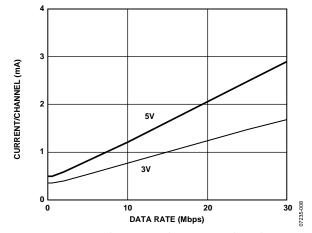


Figure 8. Typical Output Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (15 pF Output Load)

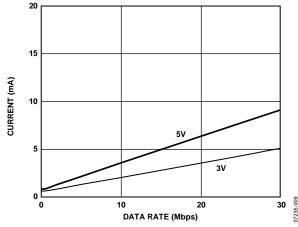


Figure 9. Typical ADuM2200  $V_{\rm DD1}$  Supply Current vs. Data Rate for 5 V and 3 V Operation

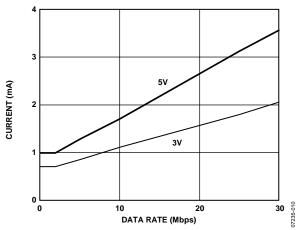


Figure 10. Typical ADuM2200  $V_{DD2}$  Supply Current vs. Data Rate for 5 V and 3 V Operation

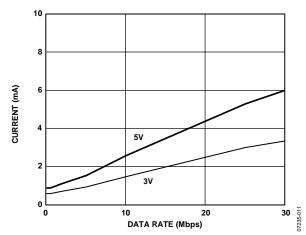


Figure 11. Typical ADuM2201 V<sub>DD1</sub> or V<sub>DD2</sub> Supply Current vs. Data Rate for 5 V and 3 V Operation

# APPLICATIONS INFORMATION PC BOARD LAYOUT

The ADuM220x digital isolator requires no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 12). Bypass capacitors are most conveniently connected between Pin 1 and Pin 3 for  $V_{\rm DD1}$  and between Pin 14 and Pin 16 for  $V_{\rm DD2}$ . The capacitor value should be between 0.01  $\mu F$  and 0.1  $\mu F$ . The total lead length between both ends of the capacitor and the input power supply pin should not exceed 20 mm. Bypassing between Pin 3 and Pin 7 and between Pin 9 and Pin 14 should be considered unless the ground pair on each package side are connected close to the package.

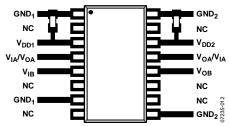


Figure 12. Recommended Printed Circuit Board Layout

In applications involving high common-mode transients, care should be taken to ensure that board coupling across the isolation barrier is minimized. Furthermore, the board layout should be designed such that any coupling that does occur equally affects all pins on a given component side. Failure to ensure this could cause voltage differentials between pins exceeding the device's Absolute Maximum Ratings, thereby leading to latch-up or permanent damage.

#### PROPAGATION DELAY-RELATED PARAMETERS

Propagation delay is a parameter that describes the length of time it takes for a logic signal to propagate through a component. The propagation delay to a logic low output can differ from the propagation delay to logic high.

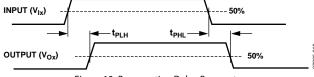


Figure 13. Propagation Delay Parameters

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the input signal's timing is preserved.

Channel-to-channel matching refers to the maximum amount the propagation delay differs among channels within a single ADuM220x component.

Propagation delay skew refers to the maximum amount the propagation delay differs among multiple ADuM220x components operated under the same conditions.

# DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

Positive and negative logic transitions at the isolator input cause narrow ( $\sim$ 1 ns) pulses to be sent via the transformer to the decoder. The decoder is bistable and is therefore either set or reset by the pulses, indicating input logic transitions. In the absence of logic transitions at the input for more than  $\sim$ 1  $\mu$ s, a periodic set of refresh pulses indicative of the correct input state is sent to ensure dc correctness at the output. If the decoder receives no internal pulses for more than approximately 5  $\mu$ s, the input side is assumed to be without power or nonfunctional; in which case, the isolator output is forced to a default state (see Table 11 and Table 12) by the watchdog timer circuit.

The limitation on the ADuM220x magnetic field immunity is set by the condition in which induced voltage in the transformer receiving coil is large enough to either falsely set or reset the decoder. The following analysis defines the conditions under which this can occur. The 3 V operating condition of the ADuM220x is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output have an amplitude greater than  $1.0~\rm V$ . The decoder has a sensing threshold at about  $0.5~\rm V$ , therefore establishing a  $0.5~\rm V$  margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

$$V = (-d\beta/dt) \sum \pi r_n^2$$
;  $n = 1, 2, ..., N$ 

where:

 $\beta$  is the magnetic flux density (gauss).

N is the number of turns in the receiving coil.

 $r_n$  is the radius of the n<sup>th</sup> turn in the receiving coil (cm).

Given the geometry of the receiving coil in the ADuM220x and an imposed requirement that the induced voltage be at most 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated as shown in Figure 14.

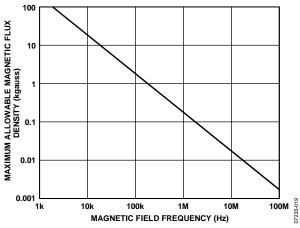


Figure 14. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kgauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event were to occur during a transmitted pulse (and was of the worst-case polarity), it would reduce the received pulse from >1.0 V to 0.75 V—still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances away from the ADuM220x transformers. Figure 15 expresses these allowable current magnitudes as a function of frequency for selected distances. As can be seen, the ADuM220x is immune and can be affected only by extremely large currents operated at high frequency and very close to the component. For the 1 MHz example noted previously, one would have to place a 0.5 kA current 5 mm away from the ADuM220x to affect operation of the component.

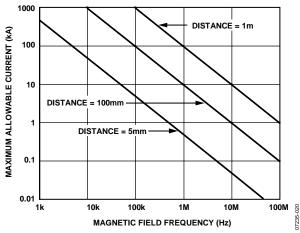


Figure 15. Maximum Allowable Current for Various Current-to-ADuM220x Spacings

Note that at combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces can induce sufficiently large error voltages to trigger the thresholds of succeeding circuitry. Care should be taken in the layout of such traces to avoid this possibility.

#### POWER CONSUMPTION

The supply current at a given channel of the ADuM220x isolator is a function of the supply voltage, the channel's data rate, and the channel's output load.

For each input channel, the supply current is given by

$$I_{DDI} = I_{DDI(Q)}$$
  $f \le 0.5 f_r$   

$$I_{DDI} = I_{DDI(D)} \times (2f - f_r) + I_{DDI(Q)}$$
  $f > 0.5 f_r$ 

For each output channel, the supply current is given by

$$I_{DDO} = I_{DDO\,(Q)}$$
  $f \le 0.5 f_r$   
 $I_{DDO} = (I_{DDO\,(D)} + (0.5 \times 10^{-3}) \times C_L \times V_{DDO}) \times (2f - f_r) + I_{DDO\,(Q)}$   
 $f > 0.5 f_r$ 

#### where:

 $I_{DDI(D)}$ ,  $I_{DDO(D)}$  are the input and output dynamic supply currents per channel (mA/Mbps).

 $C_L$  is the output load capacitance (pF).

 $V_{DDO}$  is the output supply voltage (V).

*f* is the input logic signal frequency (MHz, half of the input data rate, NRZ signaling).

 $f_r$  is the input stage refresh rate (Mbps).

 $I_{DDI(Q)}$ ,  $I_{DDO(Q)}$  are the specified input and output quiescent supply currents (mA).

To calculate the total  $I_{\rm DD1}$  and  $I_{\rm DD2}$ , the supply currents for each input and output channel corresponding to  $I_{\rm DD1}$  and  $I_{\rm DD2}$  are calculated and totaled. Figure 6 and Figure 7 provide perchannel supply currents as a function of data rate for an unloaded output condition. Figure 8 provides per-channel supply current as a function of data rate for a 15 pF output condition. Figure 9 through Figure 11 provide total  $I_{\rm DD1}$  and  $I_{\rm DD2}$  as a function of data rate for ADuM2200/ADuM2201 channel configurations.

#### **INSULATION LIFETIME**

All insulation structures eventually break down when subjected to voltage stress over a sufficiently long period. The rate of insulation degradation is dependent on the characteristics of the voltage waveform applied across the insulation. In addition to the testing performed by the regulatory agencies, Analog Devices carries out an extensive set of evaluations to determine the lifetime of the insulation structure within the ADuM220x.

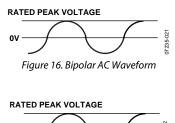
Analog Devices performs accelerated life testing using voltage levels higher than the rated continuous working voltage. Acceleration factors for several operating conditions are determined. These factors allow calculation of the time to failure at the actual working voltage. The values shown in Table 10 summarize the peak voltage for 50 years of service life for a bipolar ac operating condition and the maximum CSA/VDE approved working voltages. In many cases, the approved working voltage is higher than 50-year service life voltage. Operation at these high working voltages can lead to shortened insulation life in

The insulation lifetime of the ADuM220x depends on the voltage waveform type imposed across the isolation barrier. The iCoupler insulation structure degrades at different rates, depending on whether the waveform is bipolar ac, unipolar ac, or dc. Figure 16, Figure 17, and Figure 18 illustrate these different isolation voltage waveforms.

Bipolar ac voltage is the most stringent environment. The goal of a 50-year operating lifetime under the ac bipolar condition determines the Analog Devices recommended maximum working voltage.

In the case of unipolar ac or dc voltage, the stress on the insulation is significantly lower. This allows operation at higher working voltages while still achieving a 50 year service life. The working voltages listed in Table 10 can be applied while maintaining the 50-year minimum lifetime, provided the voltage conforms to either the unipolar ac or dc voltage cases. Any cross insulation voltage waveform that does not conform to Figure 17 or Figure 18 should be treated as a bipolar ac waveform and its peak voltage should be limited to the 50-year lifetime voltage value listed in Table 10.

Note that the voltage presented in Figure 17 is shown as sinusoidal for illustration purposes only. It is meant to represent any voltage waveform varying between 0 V and some limiting value. The limiting value can be positive or negative, but the voltage cannot cross 0 V.





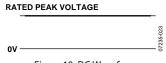
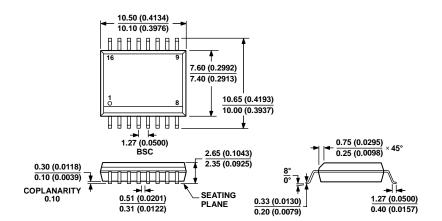


Figure 18. DC Waveform

### **OUTLINE DIMENSIONS**



COMPLIANT TO JEDEC STANDARDS MS-013-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 19. 16-Lead Standard Small Outline Package [SOIC\_W] Wide Body (RW-16) Dimensions shown in millimeters and (inches)

#### **ORDERING GUIDE**

| Model                        | Number<br>of Inputs,<br>V <sub>DD1</sub> Side | Number<br>of Inputs,<br>V <sub>DD2</sub> Side | Maximum<br>Data Rate<br>(Mbps) | Maximum<br>Propagation<br>Delay, 5 V (ns) | Maximum<br>Pulse Width<br>Distortion (ns) | Temperature<br>Range | Package Description | Package<br>Option |
|------------------------------|---|---|--------------------------------|---|---|----------------------|---------------------|-------------------|
| ADuM2200ARWZ <sup>1, 2</sup> | 2   | 0   | 1                              | 150                                       | 40  | -40°C to +105°C      | 16-Lead SOIC_W      | RW-16             |
| ADuM2200BRWZ <sup>1, 2</sup> | 2   | 0   | 10                             | 50  | 3   | -40°C to +105°C      | 16-Lead SOIC_W      | RW-16             |
| ADuM2201ARWZ <sup>1,2</sup>  | 1   | 1   | 1                              | 150                                       | 40  | -40°C to +105°C      | 16-Lead SOIC_W      | RW-16             |
| ADuM2201BRWZ <sup>1, 2</sup> | 1   | 1   | 10                             | 50  | 3   | -40°C to +105°C      | 16-Lead SOIC_W      | RW-16             |

<sup>&</sup>lt;sup>1</sup> Tape and reel is available. The addition of an -RL suffix designates a 13" (1,000 units) tape and reel option.

<sup>&</sup>lt;sup>2</sup> Z = RoHS Compliant Part.

| ADuM2200/ADuM2201 |  |
|-------------------|--|
|-------------------|--|

**NOTES** 

